ON Semiconductor

Is Now

Onsemi

To learn more about onsemi[™], please visit our website at <u>www.onsemi.com</u>

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product factures, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and asfety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or by customer's technical experts. onsemi products and actal performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application, Buyer shall indemnify and hold onsemi and its officers, employees, subsidiari



ON Semiconductor®

FDC6506P Dual P-Channel Logic Level PowerTrench[™] MOSFET

Features

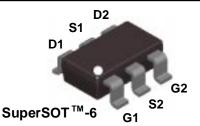
General Description

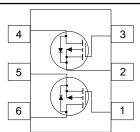
These P-Channel logic level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain low gate charge for superior switching performance.

These devices have been designed to offer exceptional power dissipation in a very small footprint for applications where the bigger more expensive SO-8 and TSSOP-8 packages are impractical.

Applications

- Load switch
- Battery protection
- Power management





• -1.8 A, -30 V. $R_{DS(on)} = 0.170 \ \Omega @ V_{GS} = -10 \ V$

• High performance trench technology for extremely

• SuperSOTTM-6 package: small footprint (72% smaller

than standard SO-8); low profile (1mm thick).

• Low gate charge (2.3nC typical).

• Fast switching speed.

low R_{DS(ON)}.

 $R_{DS(on)} = 0.280 \ \Omega \ @ V_{GS} = -4.5 \ V$

Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-30	V
V _{GSS}	Gate-Source Voltage		<u>+</u> 20	V
I _D	Drain Current - Continuous	(Note 1a)	-1.8	A
	- Pulsed		-10	
P _D	Power Dissipation for Single Operation	(Note 1a)	0.96	W
		(Note 1b)	0.9	
		(Note 1c)	0.7	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	۰C
Therma	I Characteristics			
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	130	∘C/W
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	60	∘C/W

Package Outlines and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
.506	FDC6506P	7"	8mm	3000 units

©1999 Semiconductor Components Industries, LLC. October-2017, Rev. 3 Publication Order Number: FDC6506P/D

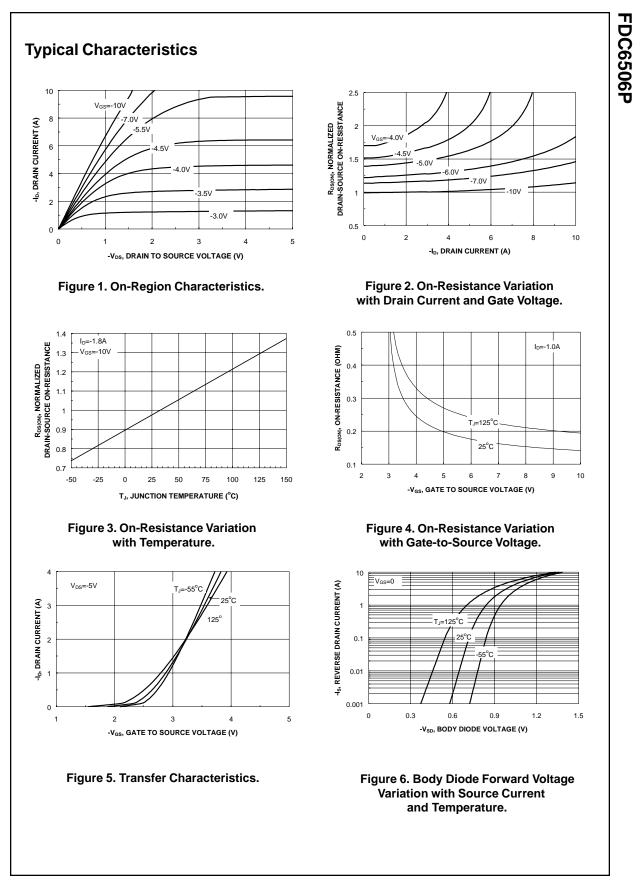
FDC6506P

	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = -250 μ A	-30			V
<u>A</u> BV⊡ss ∆Tj	Breakdown Voltage Temperature Coefficient	$I_D = -250 _{L}A$, Referenced to $25 \circ C$		-20		mV/∘C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS}=20~V,~V_{DS}=0~V$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V
<u>A</u> VGS(th) ΔTJ	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25°C		4		mV/∘C
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \text{ I}_D = -1.8 \text{ A}$ $V_{GS} = -10 \text{ V}, \text{ I}_D = -1.8 \text{ A} @ 125^{\circ}\text{C}$ $V_{GS} = -4.5 \text{ V}, \text{ I}_D = -1.4 \text{ A}$		0.14 0.20 0.22	0.17 0.27 0.28	Ω
D(on)	On-State Drain Current	$V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$	-10			А
FS	Forward Transconductance	$V_{DS} = -5 V, I_D = -1.8 A$		3		S
Dynamic	Characteristics					
	Input Capacitance	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$		190		pF
Coss	Output Capacitance	f = 1.0 MHz		70		pF
Crss Crss	Reverse Transfer Capacitance			30		pF
0		•		1	1	
	g Characteristics (Note 2)	$V_{DD} = -15 \text{ V}, \text{ I}_{D} = -1 \text{ A},$		7	14	ns
d(on) r	Turn-On Rise Time	$V_{DD} = -13 \text{ V}, \text{I}_{D} = -1 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{R}_{\text{GEN}} = 6 \Omega$		8	16	ns
d(off)	Turn-Off Delay Time			14	25	ns
d(011)	Turn-Off Fall Time	-		2	6	ns
, ל ^מ	Total Gate Charge	$V_{DS} = -5 \text{ V}, \text{ I}_{D} = -1.8 \text{ A},$ $V_{GS} = -10 \text{ V}$		2.3	3.5	nC
	Gate-Source Charge			1	0.0	nC
200	Gate-Drain Charge			0.8		nC
						-
⊋ _{gd}						
ଦ୍ର ଦୁ _ଗ Drain-So	urce Diode Characteristics and Maximum Continuous Drain-Source Dio	_			-0.8	Α

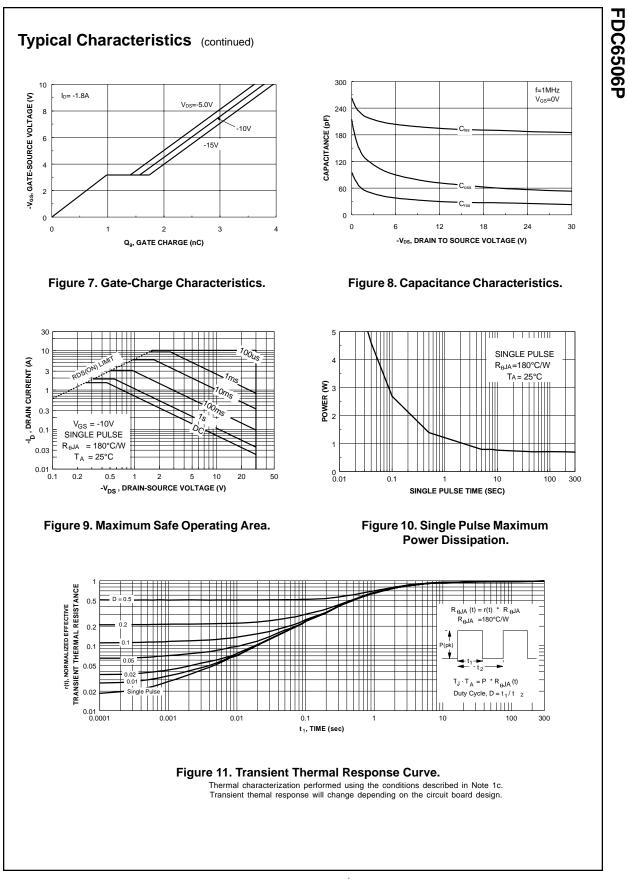
FDC6506P

Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width $\leq 300~\mu s,$ Duty Cycle $\leq 2.0\%$

www.onsemi.com 2



www.onsemi.com 3



www.onsemi.com 4

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such uninten

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi: FDC6506P